

Title (en)
LED lamp device and automated method for manufacturing said device

Title (de)
LED-Lampenvorrichtung und automatisiertes Herstellungsverfahren dieser Vorrichtung

Title (fr)
Dispositif de lampe led et procédé automatisé de fabrication dudit dispositif

Publication
EP 2554893 B1 20151014 (FR)

Application
EP 12305964 A 20120803

Priority
FR 1157138 A 20110804

Abstract (en)
[origin: EP2554893A1] The device has a main body comprising a base provided with contact studs. An LED board (8) and a card driver (7) are linked together and inserted into the body. A connector (11) connects the studs and an orifice (9) of the base. The connector is attached with a contact (14) when the card driver is inserted into the orifice. The base comprises another orifice (15). Another connector (16) connects the base with the card driver, and connects the base with the LED board when the card driver and the LED board are inserted into the orifices and arranged complementary with each other. An independent claim is also included for a method for manufacturing an LED lighting device.

IPC 8 full level
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CPC (source: EP US)
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F21V 19/0045 (2013.01 - EP); **F21V 23/006** (2013.01 - EP US); **F21Y 2103/10** (2016.07 - EP US); **F21Y 2115/10** (2016.07 - EP US)

Cited by
US2017343163A1; CN106979509A; US10253929B2; CN104684130A; EP3273159A4; WO2016091432A1

Designated contracting state (EPC)
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